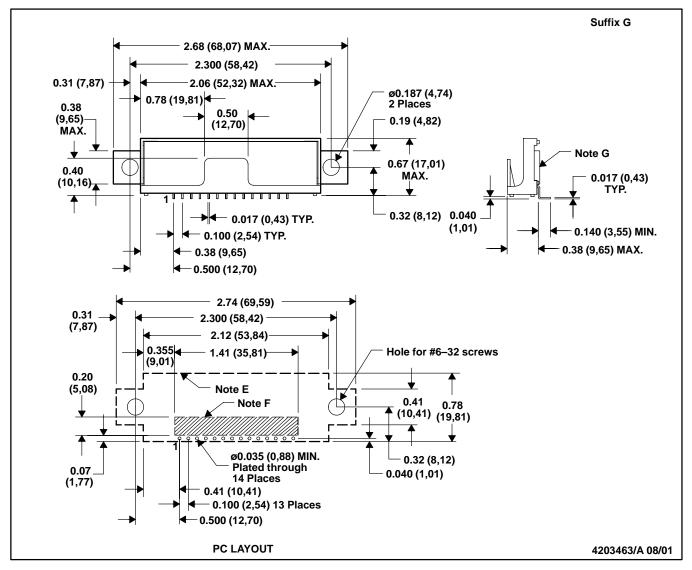
EDG (R-PSIP-T14)

PLASTIC SINGLE-IN-LINE MODULE



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. 2 place decimals are ± 0.030 (± 0.76 mm).
 - D. 3 place decimals are ± 0.010 (± 0.25 mm).
 - E. Recommended mechanical keep out area.
 - F. No copper, power or signal traces in this area.
 - G. The metal tab is isolated but electrically conductive.
 - No signal traces are allowed under the metal tab area.

A solid copper island is recommended, which may be grounded.

TEXAS INSTRUMENTS

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